

3-Axis CO₂ Laser Marker ML-Z Series

High Efficiency CO₂ Marking with Superior Flexibility

3-Axis Control CO₂ Laser Marker

RATIO CO2 Laser Ma

KEYENCE

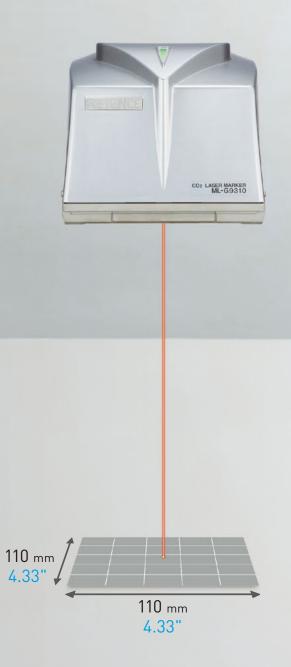
B-AXIS



Conventional Laser Marker

With conventional models, marking is limited to a fixed area.

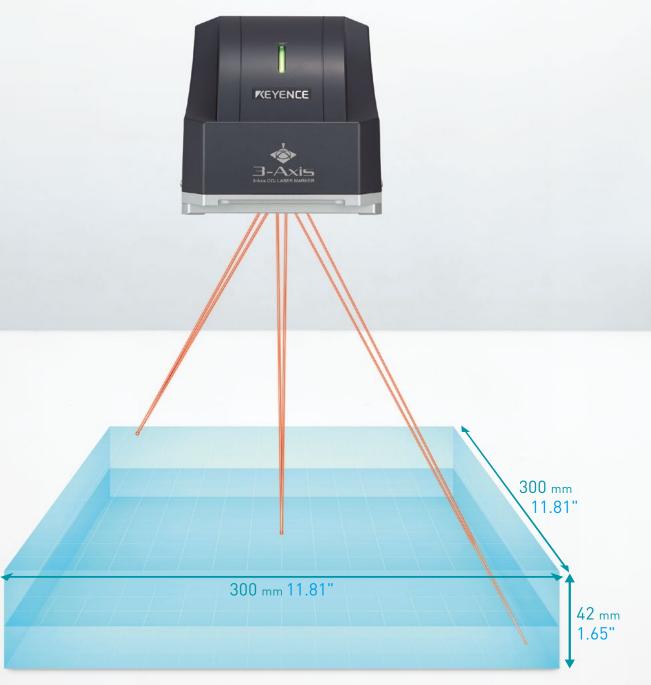




3-Axis Control ML-Z Series



With the ML-Z Series, high quality marking is possible over a wider area using 3-Axis control.



3-Axis Control Designed with Superior Flexibility for Installation and Product Changeover

Z-Axis Scanner

The ML-Z Series automatically adjusts focal distance on the fly whereas conventional models require adjustment depending on the product size and changes in the marking location.

Ability to handle inclined surfaces

Marking on three-dimensional shapes with no flaws or distortion

Products of different heights or sizes can be marked without changing any settings

COs

schology

1Significantly Reduce
Changeover Time

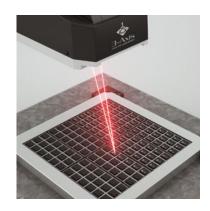
With 3-Axis control, the focal distance to the product is adjusted by the laser marker. This reduces the time and effort required for fine-tuning the focal distance compared to conventional models.



Simplify Equipment and Improve Production Efficiency

2

High-accuracy marking and processing is possible over a wide $300 \times 300 \text{ mm} 11.81^{"} \times 11.81^{"}$ area. This drastically improves production efficiency when working with a large number of products at once.



3 Unparalleled Quality and Precision

The ML-Z Series lineup includes short-wavelength and thin beam models for unparalleled marking and processing quality. These models not only eliminate unnecessary product damage but also contribute to more refined marking and processing as well as reducing total takt time.

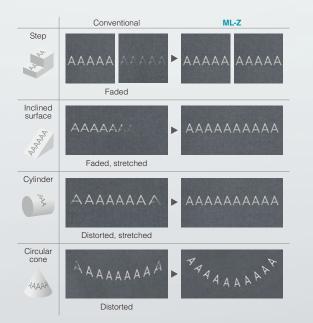




3-Axis CO₂ Laser Marker ML-Z Series 3-Axis control reduces changeover time by automatically adjusting the focal point internally

3D Marking

The ML-Z Series is equipped with 3-Axis control, a function for controlling the marking laser three-dimensionally to match the target shape. With the ability to mark on stepped, inclined, cylindrical, and conical targets, character distortion and flaws are kept to a minimum.

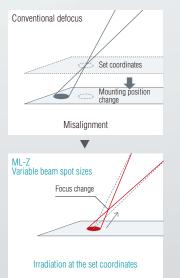


Variable Beam Spot and Defocusing

42 mm

KEYENCE

Unlike conventional beam spot defocusing techniques, the ML-Z Series can mark thin, thick, shallow or deep characters without changing coordinates or character sizes. This means that the ML-Z can mark uniform defocused characters at any point within the marking area.



Because the mounting position is physically shifted, the irradiation position and character size are also misaligned in relation to their settings.

Only the spot size is changed by adjusting the focal point. Laser irradiation at the desired coordinates with the desired spot size is possible.

Device Improvements Inline Focal Distance Adjustment

The ability to automatically adjust the focal distance allows for greater flexibility with different product sizes , shapes and inconsistencies. This eliminates the hassle of fine adjustments that require physically moving the laser head, as is required with conventional models.

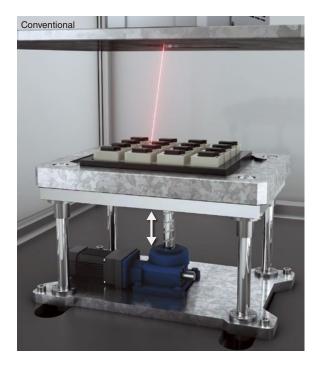




Device Improvements

Offline Focal Distance Adjustment

Automatic adjustment of the focal distance eliminates the need for fine adjustment as required with conventional models. With the ML-Z Series, simply switch the focal point setting in the software.





2

Efficient marking over a wide area

Conventional area

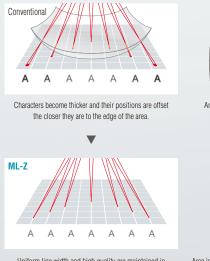
KEYENCE

110 × 110 mm 4.33" × 4.33"

300 × 300 × 42 mm

High-Accuracy Wide Area

The $300 \times 300 \times 42$ mm $11.81" \times 11.81" \times 1.65"$ wide area reduces cost by simplifying the indexing process and improves productivity by reducing indexing time. Additionally, 3-Axis control ensures the focal point reaches the entire area for high-accuracy marking and processing.



Uniform line width and high quality are maintained in the entire area.

Area is distorted by the lens characteristics

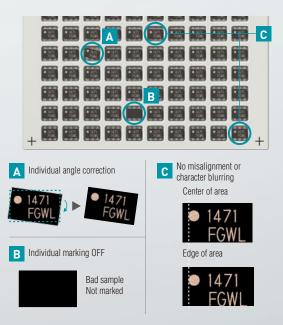


				Γ
				Γ
				Γ
				Γ

Area is free of deformation/distortion

Matrix Marking Function

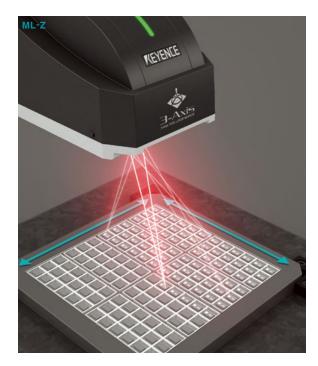
Up to 65,025 items can be arranged in a single marking layout. This allows optimum marking and processing of multiple parts in a single tray. The ML-Z Series is also capable of accommodating misaligned targets using tilt correction.



Device Improvements Reduce XY Motion with Larger Marking Area

With conventional models, products that did not fit within the marking area had to be moved using an XY stage. With the ML-Z, marking can be performed uniformly over a wide area, so stage mechanisms and control programs can be reduced or eliminated all together.

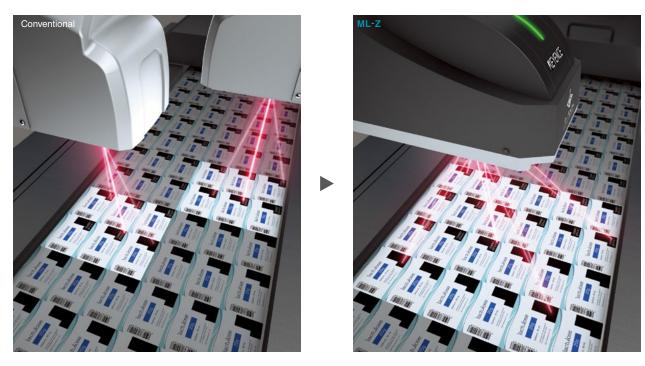




Device Improvements

Batch Marking of Multiple Targets

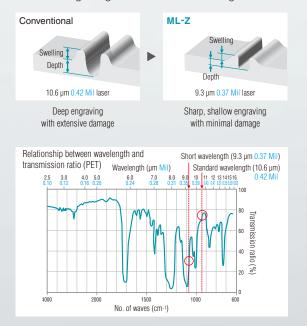
With a larger marking area than conventional models, the ML-Z Series is able to mark multiple products at once over a larger area or a higher quantity of products. This allows for improved production efficiency.



Extensive lineup provides higher quality and shorter takt times

9.3 µm 0.37 Mil Short Wavelength Model

The wavelength of the ML-Z Series' laser is available at 10.6 μ m 0.42 Mil as well as a shortened 9.3 μ m 0.37 Mil to better suit the heat absorption characteristics of various resins. With a higher absorption rate in resin, this shorter wavelength allows for more precise marking with shallower engraving and less surface swelling.



Thin Beam Model

Compared with standard models, the laser spot diameter is smaller, enabling even finer marking. The smaller spot diameter allows for greater power density, which in turn allows for more efficient processing such as cutting and drilling.

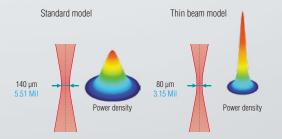
Comparison of Laser Spot Diameter and Power Density

	Standard model	Thin beam model
Spot diameter	140 µm 5.51 Mil	80 µm 3.15 Mil
Power density	2.0 kW/mm ²	6.0 kW/mm ²

* These are representative values.

10

0



Thin laser beam models provide greater power density with a narrower spot diameter.

Sharper Results Through Reduced Product Damage Improvements



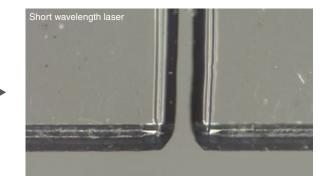
Device

Short Wavelength Model



Cross section of cut film

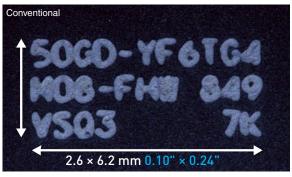


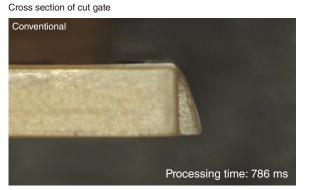


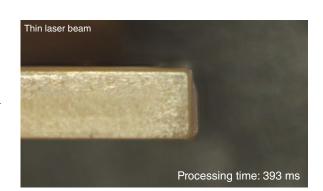
Device Improvements

Improve Efficiency and Clarity Through Finer Marking

Marking on IC chips







50GD-YF6TG4

M08-FHW 849

7K

Thin Beam Model

Thin laser beam

VSQ3

Marking Builder 3 Software

Sample Marking Function

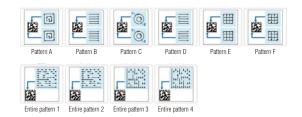
The optimal marking settings can easily be found by varying multiple parameters at once. By simply selecting the optimum sample from the provided marking results, anyone can quickly and easily obtain the best marking settings with minimal effort or knowledge of the system.



The listed marking results makes it easy to see which settings are best.

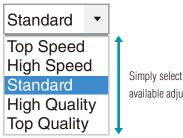
2D Code Pattern Selection

Marking patterns can affect the way a barcode is illuminated and how well it is identified by the code reader. The Marking Builder 3 software allows for ultimate flexibility in pattern selection with more than 10 patterns to choose from and many more combinations possible.



Quality Adjustment Level

The software automatically calculates the adjustments needed to either emphasize higher speed or higher quality by simply selecting the quality level desired.



Simply select one of the five available adjustment levels.

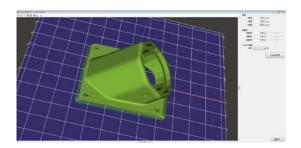
Printer Driver Function

A variety of file types—such as Excel, Word, PDF, and bitmap can be imported directly into the laser marker software. With the printer driver function, the laser marker is able to print similarly to your standard office printer.



Z-MAP Creator

Using 3D CAD data (STL format), the actual profile of the target can be imported into Marking Builder 3 and used as the base of the layout. This enables users to configure settings and perform marking on targets that have complicated profiles which cannot be expressed with basic shapes such as cylinders and step height changes.



Global Models

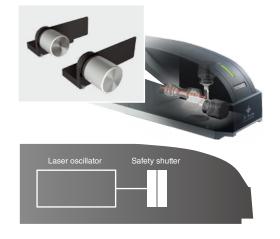
ISO 13849-1 Compliant

Built-in safety shutters

Two safety shutters that comply with the ISO 13849-1 international standard are incorporated in the marking unit. These shutters are used to shut off the laser light directly.

Significantly reduce downtime

The emergency stop input for conventional models cuts power to the laser oscillator power supply, so restarting the system can take a long time. The safety shutter, however, prevents the need to cut power completely, allowing for improved efficiency by reducing the recovery time to no more than 0.5 seconds.



Easy Connection to Peripheral Equipment

PROFINET, EtherNet/IP™

Peripheral equipment connectivity and networking capabilities have been improved with the addition of PROFINET and EtherNet/IP[™] communication. This also makes it possible to connect to devices remotely in order to check on operations and save communication history. In addition, connection between individual devices is possible with just a single LAN cable via Ethernet. Visualization of product information and individual equipment statuses makes creation of a traceability system easy.

Total support from KEYENCE

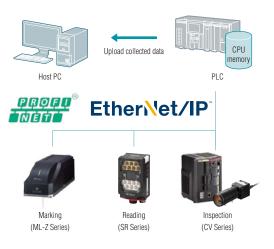
KEYENCE also offers peripheral marking process equipment. With equipment provided by the same manufacturer, cooperation between devices increases and installation and setup effort is reduced. Responding to unforeseen troubles is also quicker.

Global Support System

Follow-up assistance from both national and local staff

KEYENCE provides generous support from both national technical staff and local technical staff even for customers with production bases overseas. Because KEYENCE is a direct sales manufacturer, customers are able to receive responses in a very short time. When going through a distributor, troubleshooting takes time and often is only available in the local tongue.

Traceability system construction example



Ordinary manufacturers



Onsite line operations stall while waiting for support



Applications

Food/Pharmaceutical Industry





KM23051



PTP sheets

IC chips

SV6D12

MODEL MFG.DATE

WEIGHT

Nameplates

Heat seals

Cartons

Electronic Devices Industry





Electronic PCBs

Weatherstripping



MADE IN JAPAN



Ceramics

Glass wafers

Automotive Industry



Seat rails

Processing/Decorative Applications



Film cutting and hole cutouts



Gate cutting



FI CORPORATION

Sheathing cutting



Air filters



Design marking



Specifications

		Standar	d model	Wide area type		Thin laser beam				
	Marking unit	ML-Z9610	ML-Z9610T	ML-Z9620	ML-Z9620T	ML-Z9650	ML-Z9650T			
Model	Controller	ML-Z9600								
	Console (Color touch panel)			MC	-P1					
Marking style				XYZ 3-Axis simultane	eous scanning method					
		CO ₂ Laser, Class 4 Laser Product (IEC/EN60825-1, JIS C6802, FDA (CDRH) Part 1040.10*1)								
Marking laser	Wavelength	10.6 µm 0.42 Mil	9.3 µm 0.37 Mil	10.6 µm 0.42 Mil	9.3 µm 0.37 Mil	10.6 µm 0.42 Mil	9.3 µm 0.37 Mil			
	Output*2	30 W	20 W	30 W	20 W	30 W	20 W			
Guide laser / wor	king distance pointer	Semicon	ductor laser, Wavelength: 65	5 nm, Output: 1.0 mW Class	2 Laser (IEC/EN60825-1, JIS	S C6802, FDA (CDRH) Part 10	040.10*1)			
Marking area		120 × 120 × 42 mm 4	4.72" × 4.72" × 1.65"	300 × 300 × 42 mm 11.81" × 11.81" × 1.65"		50 × 50 × 4 mm 1.97" × 1.97" × 0.16"				
Standard working distance (±variation width)		189 mm 7.44" (±21 mm ±0.83")		300 mm 11.81" (±21 mm ±0.83")		92 mm 3.62" (±2 mm ±00.8")				
Marking resolution		2 μm 0.08 Mil		5 μm 0.20 Mil		1 µm 0.04 Mil				
Scan speed		12000 mm 39.37'/s max.		6000 mm 19.69'/s max.		6000 mm 19.69'/s max.				
Character type	Font	KEYENCE original font (numerical value, alphabet, katakana, hiragana and kanji) / user font / TrueType font / OpenType font*3								
	Barcode	CODE39/CODE93/CODE128/ITF/2of5/NW7(Codabar)/JAN/EAN/UPC-A/UPC-E								
	2D code	QR code / micro QR code / DataMatrix (ECC200 / GS1 DataMatrix)								
	GS1 DataBar	GS1 DataBar (Truncated)/GS1 DataBar Stacked/GS1 DataBar Limited/ GS1 DataBar (Truncated) CC-A/GS1 DataBar Stacked CC-A/GS1 DataBar Limited CC-A								
	Logo image	Custom font, logo (DXF) data BMP/JPEG/PNG/TIF								
	Marking style	Stationary marking / movement marking (constant speed / encoder)								
Marking	Character size (height × width)	0.2 to 120 mm	0.008" to 4.72"	0.3 to 300 mm (0.012" to 11.81"	0.1 to 50 mm	0.004" to 1.97"			
arking onditions	Number of registered programs	2000 settings max.								
	Number of blocks			256 b	olocks					
Input / Output			Terminal block ir	nput and output / MIL connecto	or input and output / Europea	n input and output				
Interface				RS-232C/USB2.0/Ethernet	(100BASE-TX/10BASE-T)*4					
Marking unit inst	allation direction	All directions								
Marking unit cab	le length	5 m 16.40'								
Cooling method		Forced air cooling								
Rated voltage an	d power consumption	Single-phase 100 to 240 VAC ±10%, 50/60 Hz, 1000 VA max.								
Overvoltage cate	gory	I II								
Pollution degree		2								
	Ambient temperature for storage	-10 to +60°C 14 to 140°F, No freezing								
Environmental	Ambient temperature for usage	0 to 40°C 32 to 104°F								
resistance	Ambient humidity for storage	30 to 85%. No condensation								
	Ambient humidity for usage									
	Controller			10.5	5 kg					
Weight	Marking unit	16.3	kg	16.4	4 kg	16.	3 kg			
	Console) kg					
Compatible regu	ations		EU Directives/E	N Standards, CSA Standards a	Ind UL Standards, North Amer	rican Regulations				

orki

*1 The laser classification for FDA (CDRH) is implemented based on IEC60825-1 in accordance with the requirements of Laser Notice No.50.

The lase classification or PA (CVHr) is implemented based on ECV002-5 in accordance with the requirements of case Notice No. *2 Laser tube monithic output *3 The only TrueType and OpenType fonts supported are those fonts whose "Font embeddability" property is set to "Installable" or "Editable". This property can be viewed from the Properties dialog box of the font shown on the [Fonts] screen in [Control Panel]. *4 The USB point is designed for use with USB memory sticks, USB mouses, barcode readers (A connector), and Marking Builder 3 (ActiveX) (B connector). The Ethernet port supports communication with Marking Builder 3 (ActiveX), TCP/IP communication, PROFINET connection, and EtherNet/IP^{IM} connection.

PC software specifications (optional)

Model	Description			
MB3-H2D4-DVD	Marking Builder 3 Version 4*1 2D setting and editing software (focal distance, inclination correction, variable spot, distance pointer adjustment)			
MB3-H3D1 3D add-in software for Marking Builder 3 (marking on plane, cylinder, cone, or sphere; Z-MAP marking)				
*1 Marking Builder 3 Version 2 and Version 3 and Marking Builder	2 Version 7 are also available			

6 × M4, Depth 6 0.24" max.

Load

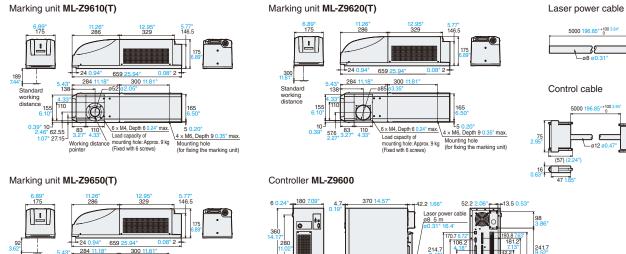
3.27" 4.33" Load capacity of Working distance pointer (Fixed with 6 screws)

110

point

69.4 19.4

¹¹ Marking builder 3 Version 2 and Version 3, and Marking Builder 2 Version 7 are also available.
Supported operating systems: Windows 10, 8 1, 8 7 (SP to relate). Supported operating systems: Windows 10, 8 1, 8 7 (SP to relate). Supported oparating systems: Building and Section 3.
Windows is either registered trademark or trademark of Microsoft Corporation in the United States and/or other countries.



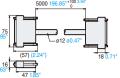
4-a21

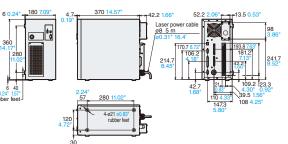
4 × M6, Depth 9 0.35" max.

Mounting hole (for fixing the marking unit)

Unit: mm inch

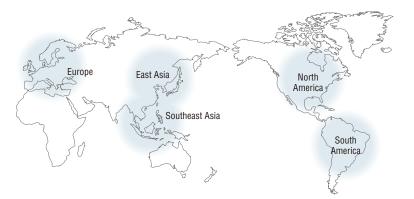
50 1.97





LASER MARKERS USED AROUND THE WORLD

The ML-Z Series supports various international standards and regulations. Through our world-wide direct-sales network, KEYENCE provides its customers with direct support no matter what country our customers are in.



LOCAL, IN-HOUSE TESTING LABS

Our customers have access to these test services provided by our dedicated sales engineers.

To request a test, visit the KEYENCE website or contact your nearest **KEYENCE** office.



SAFETY PRECAUTIONS

- Be sure to read the manual and fully understand its contents before using the product.
- Do not allow your eyes or skin to be exposed to a directly irradiated laser beam or a diffused reflection laser beam.



KEYENCE TO CONTACT YOUR LOCAL OFFICE CALL | TOLL **1-888-KEYENCE** FREE 1 - 8 8 8 - 5 3 9 - 3 6 2 3





CONTACT YOUR NEAREST OFFICE FOR RELEASE STATUS

KEYENCE CORPORATION OF AMERICA

	e bouloraia, oullo	200, 110000, 1	L 60143, U.S.A.	FIUNE. +1-201-93	J-0100 FAX: +1-8;	55-539-0123	E-mail: keyence@key	/ence.com	
AR Little Rock CA AZ Phoenix CA	Cupertino FL Los Angeles G/	. Tampa A At l anta	IN Indianapolis KY Louisville	MI Grand Rapids I MN Minneapolis	J Elmwood Park Y Rochester	NC Raleigh OH Cincinnati OH Cleveland OR Portland	PA Philadelphia PA Pittsburgh SC Greenville TN Knoxville	TN Nashville TX Austin TX Dallas WA Seattle	WI Milwaukee
KEYENCE CANADA INC							KEYENCE MEXICO		
				icecanada@keyence.co INE: +1-905-366-7655		22	PHONE: +52-55-8850 E-mail: keyencemexic		1-8220-9097

The information in this publication is based on KEYENCE's internal research/evaluation at the time of release and is subject to change without notice. Company and product names mentioned in this catalog are either trademarks or registered trademarks of their respective companies. The specifications are expressed in metric units. The English units have been converted from the original metric units.

Copyright (c) 2017 KEYENCE CORPORATION. All rights reserved.